



AEC-Q200

This component was always
RoHS compliant from the first
date of manufacture.

- Surface Mount 3.0 x 3.0 mm Package
- Complies with Directive 2002/95/EC (RoHS)

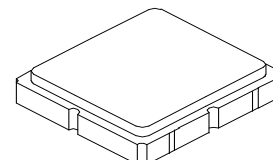


Absolute Maximum Ratings

Rating	Value	Units
Input Power Level	10	dBm
DC Voltage	3	V
Operable Temperature Range	-45 to +125	°C
Specification Temperature Range	-40 to +85	°C
Storage Temperature Range in Tape and Reel	-40 to +85	°C

SF2419E

495 MHz SAW Filter



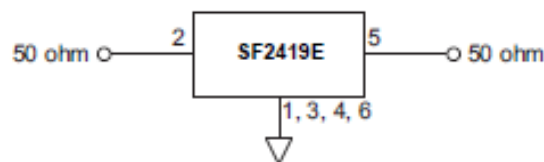
SM3030-6

Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Center Frequency	f_c			495		MHz
Insertion Loss (490 to 500 MHz)	IL			1.9	3.5	dB
Amplitude Ripple (490 to 500 MHz)				0.6	1.5	
VSWR (490 to 500 MHz)				1.3	2.3	
Attenuation, Referenced from 0 dB						dB
Fc-45.8 to Fc-39.8 MHz			50	58		
Fc+39.8 to Fc+45.8 MHz			43	49.5		
Temperature Coefficient of Frequency				-36		ppm/°C
Case Style	SM3030-6 3.0 x 3.0 mm Nominal Footprint					
Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator	7Z, YWWS					
Standard Reel Quantity	Reel Size 7 Inch	500 Pieces/Reel				
	Reel Size 13 Inch	3000 Pieces/Reel				

Electrical Connections

Connection	Terminals
Input	2
Output	5
Case Ground	All others

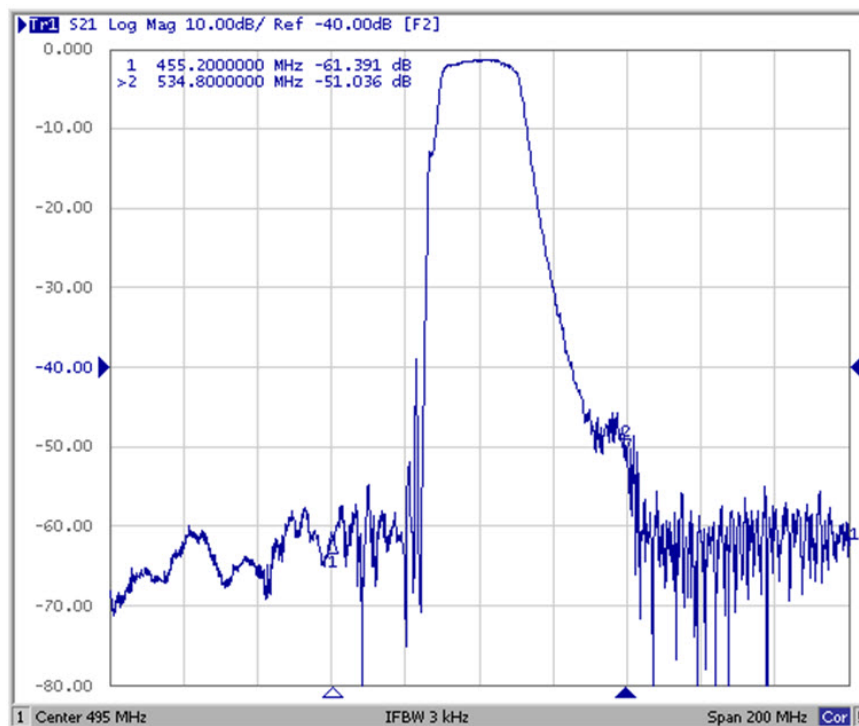
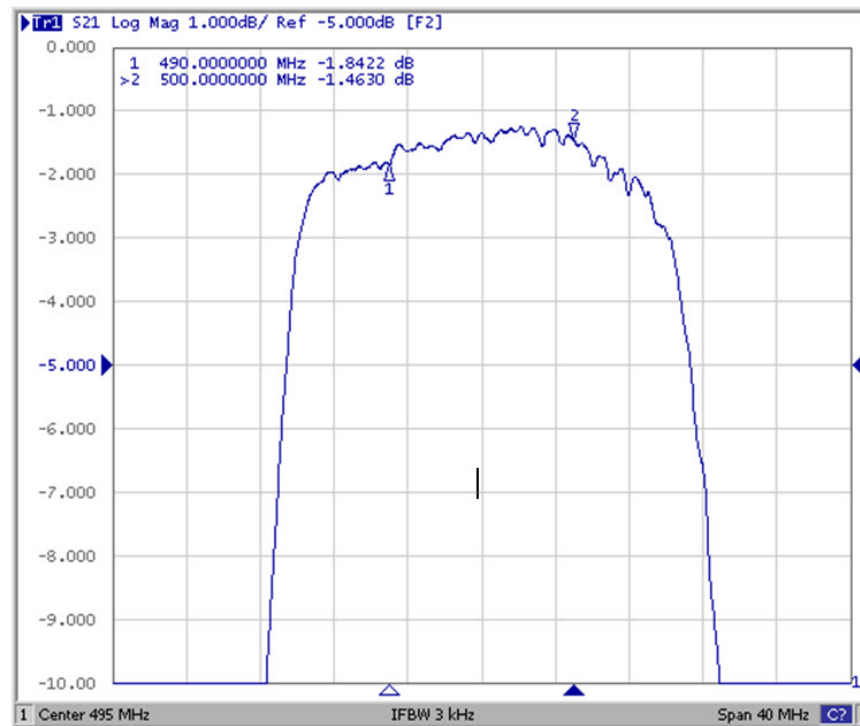


CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

NOTES:

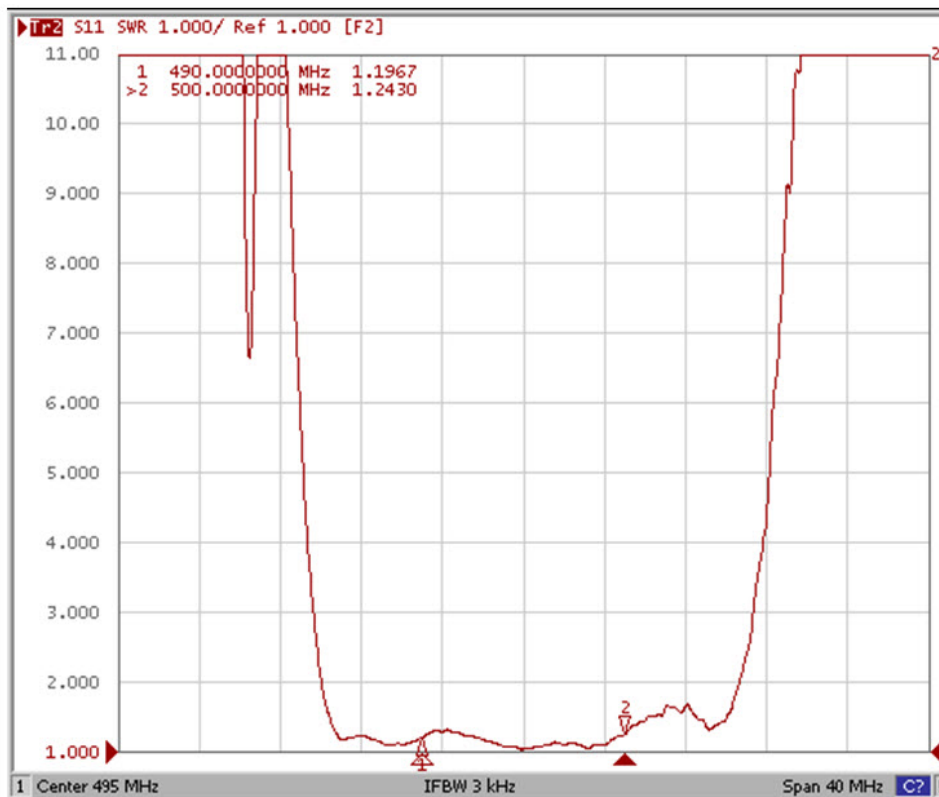
1. The design, manufacturing process, and specifications of this device are subject to change.
2. US or International patents may apply.

Frequency Characteristics:

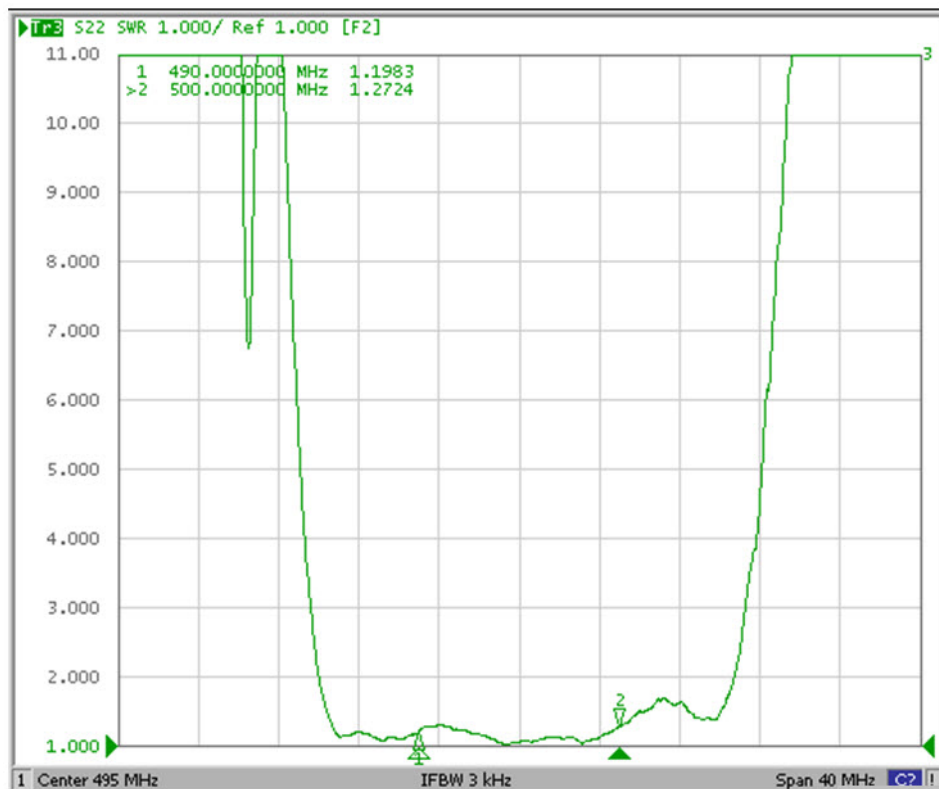


Reflection Functions:

S11

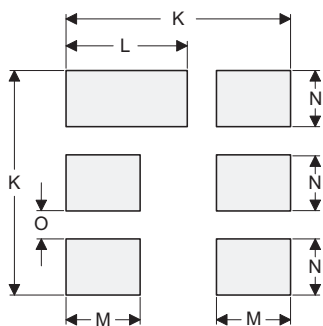
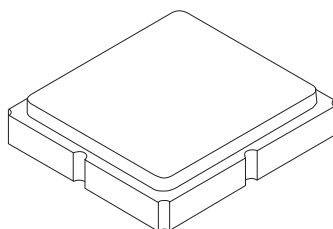


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SM3030-6 Case

6-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint



PCB Footprint Top View

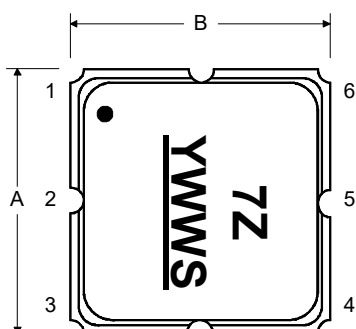
Case and PCB Footprint Dimensions

Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	2.99	3.00	3.01	0.117	0.118	0.118
B	2.99	3.00	3.01	0.117	0.118	0.118
C	-	-	1.40	-	-	0.055
D	-	-	1.00	-	-	0.039
E	-	2.80	-	-	0.110	-
F	-	1.60	-	-	0.063	-
G	-	0.85	-	-	0.033	-
H	-	1.50	-	-	0.059	-
I	-	0.60	-	-	0.024	-
J	-	1.30	-	-	0.051	-
K	-	3.20	-	-	0.126	-
L	-	1.70	-	-	0.067	-
M	-	1.05	-	-	0.041	-
N	-	0.81	-	-	0.032	-
O	-	0.38	-	-	0.015	-

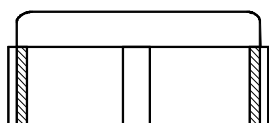
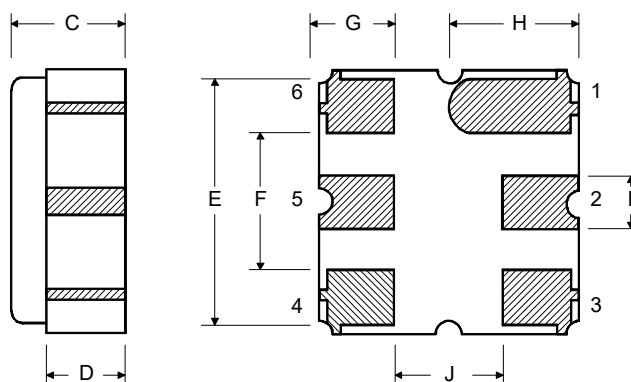
Case Materials

Materials	
Solder Pad Plating	0.3 to 1.0 μ m Gold over 1.27 to 8.89 μ m Nickel
Lid Plating	2.0 to 3.0 μ m Nickel
Body	Al ₂ O ₃ Ceramic
Pb Free	

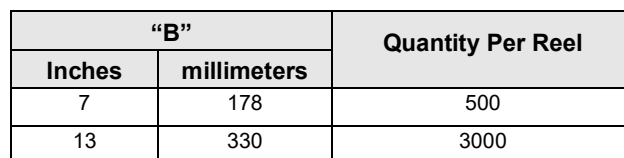
TOP VIEW



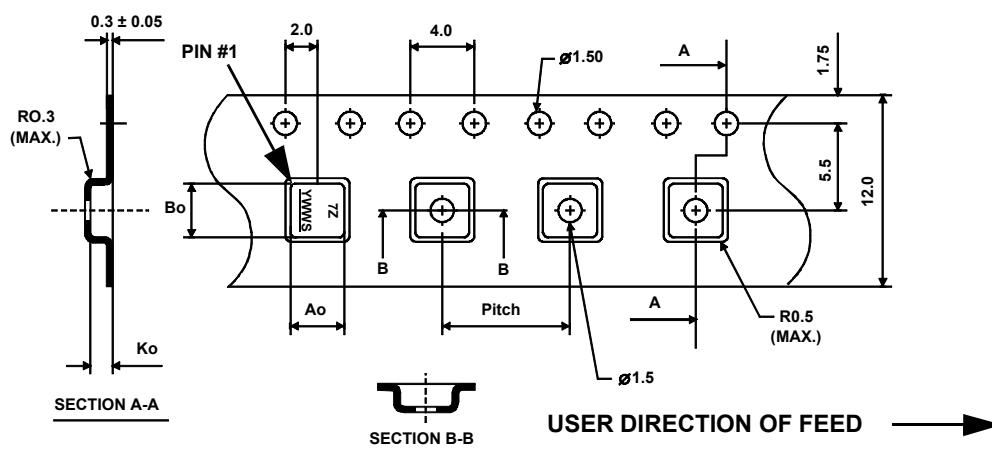
BOTTOM VIEW



Tape and Reel Standard per ANSI/EIA-481



Carrier Tape Dimensions	
Ao	3.35 mm
Bo	3.35 mm
Ko	1.40 mm
Pitch	8.0 mm
W	12.0 mm



Recommended Reflow Profile

1. Preheating shall be fixed at 150~180°C for 60~90 seconds.
2. Ascending time to preheating temperature 150°C shall be 30 seconds min.
3. Heating shall be fixed at 220°C for 50~80 seconds and at 260°C +0/-5°C peak (10 seconds).
4. Time: 5 times maximum.



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